INTEGRATED CIRCUITS

DATA SHEET

74F253Dual 4-bit input multiplexer (3-State)

Product specification

1988 Nov 29

IC15 Data Handbook





74F253

FEATURES

- 3-State outputs for bus interface and multiplex expansion
- Common select inputs
- Separate Output Enable Inputs

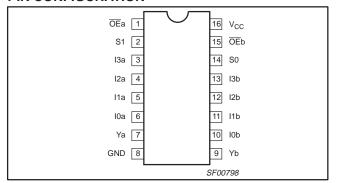
DESCRIPTION

The 74F253 has two identical 4-input multiplexers with 3-State outputs which select two bits from four sources selected by common Select inputs (S0, S1). When the individual Output Enable (OEa, OEb) inputs of the 4-input multiplexers are High, the outputs are forced to a high impedance (Hi-Z) state.

The 74F253 is the logic implementation of a 2-pole, 4-position switch; the position of the switch being determined by the logic levels supplied to the two common Select inputs.

To avoid exceeding the maximum current ratings when the outputs of the 3-State devices are tied together, all but one device must be in the high-impedance state. Therefore, only one Output Enable must be active at a time.

PIN CONFIGURATION



TYPE	TYPICAL PROPAGATION DELAY	TYPICAL SUPPLY CURRENT (TOTAL)
74F253	7.0ns	12mA

ORDERING INFORMATION

	COMMERCIAL RANGE	
DESCRIPTION	V _{CC} = 5V ±10%, T _{amb} = 0°C to +70°C	PKG DWG #
16-pin plastic DIP	N74F253N	SOT38-4
16-pin plastic SO	N74F253D	SOT109-1

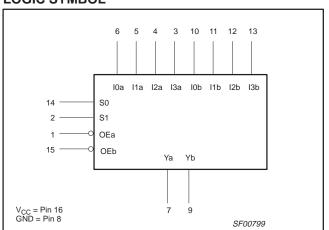
INPUT AND OUTPUT LOADING AND FAN-OUT TABLE

PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW
I0a-I3a	Port A data inputs	1.0/1.0	20μA/0.6mA
I0b-I3b	Port B data inputs	1.0/1.0	20μA/0.6mA
S0, S1	Common Select inputs	1.0/1.0	20μA/0.6mA
OE a	Port A Output Enable input (active Low)	1.0/1.0	20μA/0.6mA
OE b	Port B Output Enable input (active Low)	1.0/1.0	20μA/0.6mA
Ya, Yb	3-State outputs	150/40	3mA/24mA

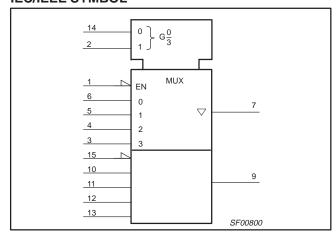
NOTF:

One (1.0) FAST unit load is defined as: $20\mu A$ in the High state and 0.6mA in the Low state.

LOGIC SYMBOL



IEC/IEEE SYMBOL

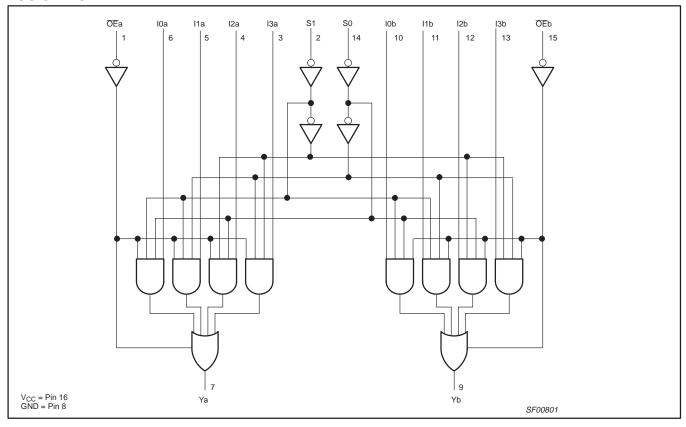


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Dual 4-input multiplexer (3-State)

74F253

LOGIC DIAGRAM



FUNCTION TABLE

			INPUTS			OUTPUT	
S0	S1	10	l1	I2	13	ŌĒ	Υ
Х	Х	Х	Х	Х	Х	Н	Z
L	L	L	Х	Х	Х	L	L
L	L	Н	Х	Х	Х	L	Н
Н	L	Х	L	X	Х	L	L
Н	L	Х	Н	Х	Х	L	Н
L	Н	Х	Х	L	Х	L	L
L	Н	Х	Х	Н	Х	L	Н
Н	Н	Х	Х	Х	L	L	L
Н	Н	Х	Х	Х	Н	L	Н

NOTES:

H = High voltage level
L = Low voltage level
X = Don't care
Z = High impedance "off" state

Philips Semiconductors Product specification

Dual 4-input multiplexer (3-State)

74F253

ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	−0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	-30 to +5	mA
V _{OUT}	Voltage applied to output in High output state	–0.5 to V _{CC}	V
I _{OUT}	Current applied to output in Low output state	48	mA
T _{amb}	Operating free-air temperature range	0 to +70	°C
T _{stg}	Storage temperature	-65 to +150	°C

RECOMMENDED OPERATING CONDITIONS

SYMBOL	DADAMETED		LIMITS						
STWIBUL	PARAMETER	MIN	NOM	MAX	UNIT				
V _{CC}	Supply voltage	4.5	5.0	5.5	V				
V _{IH}	High-level input voltage	2.0			V				
V _{IL}	Low-level input voltage			0.8	V				
I _{IK}	Input clamp current			-18	mA				
I _{OH}	High-level output current			-3	mA				
I _{OL}	Low-level output current			24	mA				
T _{amb}	Operating free-air temperature range	0		70	°C				

Philips Semiconductors Product specification

Dual 4-input multiplexer (3-State)

74F253

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

							LIMITS		
SYMBOL	PARAMETE	₹	TEST COND	ITIONS ^{NO TAG}		MIN	TYP NO TAG	MAX	UNIT
.,	Lligh lovel output voltage		V _{CC} = MIN, V _{IL} = MAX,	$V_{CC} = MIN, V_{II} = MAX,$ $\pm 10\% V_{CC}$					V
V _{OH}	High-level output voltage	;	$V_{IH} = MIN, I_{OH} = MAX$		±5%V _{CC}	2.7	3.3		V
.,	I am laval autoritualta ea		$V_{CC} = MIN, V_{II} = MAX,$		±10%V _{CC}		0.35	0.50	V
V _{OL}	Low-level output voltage		$V_{IH} = MIN, I_{OL} = MAX$	±5%V _{CC}		0.35	0.50	V	
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$		-0.73	-1.2	V		
I _I	Input current at maximur voltage	n input	$V_{CC} = MAX, V_I = 7.0V$			100	μА		
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$			20	μΑ		
I _{IL}	Low-level input current		$V_{CC} = MAX, V_I = 0.5V$			-0.6	mA		
I _{OZH}	Off-state output current High-level voltage applie	d	$V_{CC} = MAX, V_O = 2.7V$					50	μΑ
I _{OZL}	Off-state output current Low-level voltage applie	d	$V_{CC} = MAX, V_{O} = 0.5V$	$V_{CC} = MAX, V_{O} = 0.5V$				-50	μА
Ios	Short-circuit output curre	nt ^{NO} TAG	V _{CC} = MAX		-60		-150	mA	
		I _{CCH}		OEn=GND, S	Sn=In=4.5V		10	16	mA
I _{CC}	Supply current (total) I _{CCL}	$V_{CC} = MAX$	OEn=Sn=In=GND		12	23	mA		
		I _{CCZ}		OEn=4.5V, S	n=In=GND		14	23	mA

NOTES:

1. For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

All typical values are at V_{CC} = 5V, T_{amb} = 25°C.
 Not more than one output should be shorted at a time. For testing I_{OS}, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a High output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

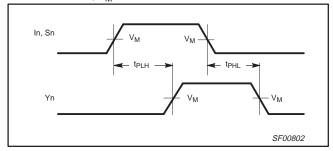
74F253

AC ELECTRICAL CHARACTERISTICS

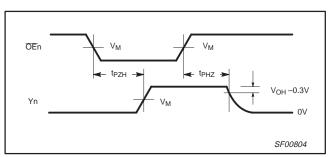
					LIN	MITS		
SYMBOL	PARAMETER	TEST CONDITION		V _{CC} = +5V _{amb} = +25° C _L = 50pF R _L = 500Ω	'	V _{CC} = +5 T _{amb} = 0°0 C _L = R _L =	UNIT	
			MIN	TYP	MAX	MIN	MAX	
t _{PLH} t _{PHL}	Propagation delay In to Yn	Waveform NO TAG	3.0 3.0	4.5 5.0	7.0 7.0	3.0 3.0	7.5 8.0	ns
t _{PLH} t _{PHL}	Propagation delay Sn to Yn	Waveform NO TAG	4.5 5.0	7.5 8.5	10.5 11.0	4.5 4.5	11.0 12.0	ns
t _{PZH}	Output Enable time to High or Low level	Waveform 2 Waveform 3	3.0 3.0	6.5 6.5	8.0 8.0	3.0 3.0	9.0 9.0	ns
t _{PHZ} t _{PLZ}	Output Disable time from High or Low level	Waveform 2 Waveform 3	2.5 2.0	3.5 3.0	5.0 5.0	2.0 1.5	6.0 6.0	ns

AC WAVEFORMS

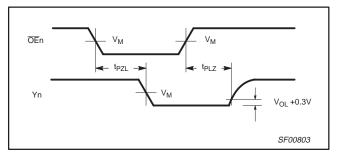
For all waveforms, $V_M = 1.5V$



Waveform 1. Propagation Deley, Data and Select to Output



Waveform 2. 3-State Output Enable Time to High Level and Output Disable Time from High Level



Waveform 3. 3-State Output Enable Time to Low Level and Output Disable Time from Low Level

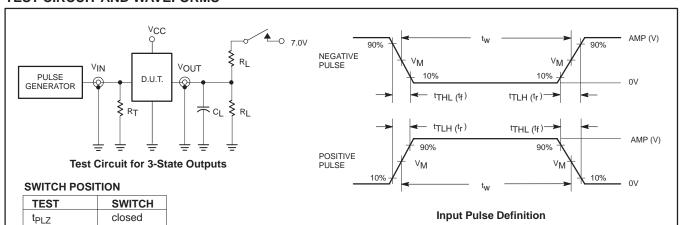
1988 Nov 29 6

Philips Semiconductors Product specification

Dual 4-input multiplexer (3-State)

74F253

TEST CIRCUIT AND WAVEFORMS



All other

 t_{PZL}

DEFINITIONS: R_L = Load resistor;

closed

open

see AC electrical characteristics for value.
Load capacitance includes jig and probe capacitance; see AC electrical characteristics for value.

Termination resistance should be equal to $Z_{\mbox{\scriptsize OUT}}$ of pulse generators.

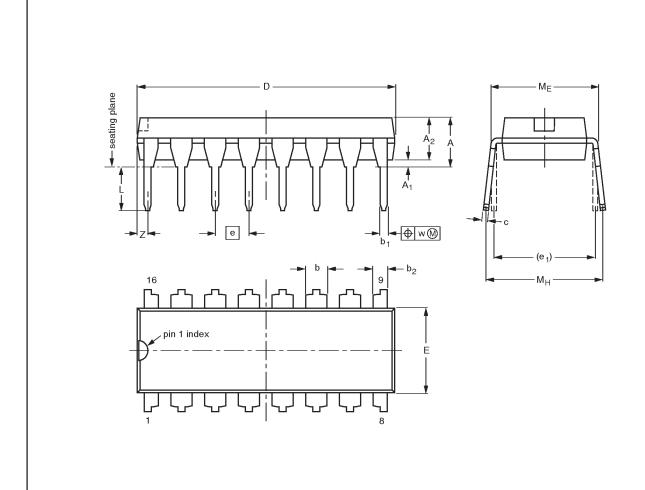
family	INP	UT PU	LSE REQU	REMEN	TS	
	amplitude	V_{M}	rep. rate	t _w	t _{TLH}	t _{THL}
74F	3.0V 1.5		1MHz	500ns	2.5ns	2.5ns

SF00777

74F253

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	C	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	Мн	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

10 mm

Note

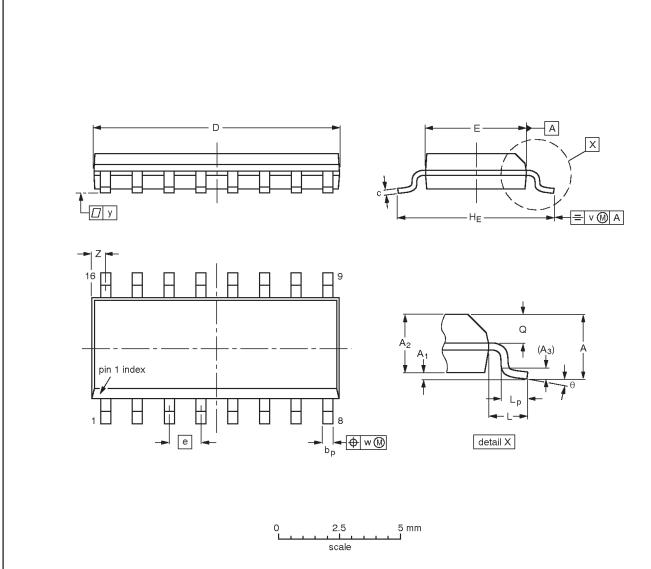
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT38-4				□ •	92-11-17 95-01-14	

74F253

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

							_											
UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Ø	٧	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075		0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ	PROJECTION	
SOT109-1	076E07S	MS-012AC			95-01-23 97-05-22

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Dual 4-input multiplexer (3-State)

74F253

Data sheet status

Data sheet status	Product status	Definition [1]	
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.	
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later data. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.	
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible process.	

^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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